

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	6651	(257/100,684,778,787).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 12:21
L2	4411	(333/32,187,193).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 12:21
L3	1089	(310/313,348).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 12:21
L4	290	((wire conductor bus line) near3 (size length width characteristic)) with (frequency near3 response)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 12:43
L5	34	wire near3 resonat\$3 near3 vibrat\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/03 12:47
L6	0	wire near3 resonat\$3 near3 (vibrat\$4 near3 break\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/03 14:02
L7	0	wire near3 resonat\$3 near3 (vibrat\$4 with break\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/03 12:46
L8	0	wire near3 resonat\$3 near3 (vibrat\$4 and break\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/03 12:46
L9	4	wire near3 resonat\$3 near3 (vibrat\$4) and break\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/03 12:46

L10	0	(wire near3 resonat\$3 near3 (vibrat\$4) and break\$3).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/03 12:46
L11	3	(wire near3 resonat\$3 near3 vibrat\$4).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/03 12:48
L12	31	I5 not I11	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/03 13:49
L13	1618	(257/690).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 13:52
L14	1113	(361/776,777).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 13:54
L15	93	I14 and frequencies	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 13:53
L16	221	I14 and frequenc\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 13:54
L17	1613	(361/776,777,778,779).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 13:54
L18	280	I17 and frequenc\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 14:00
L19	143	I18 and substrate and (IC or die or component)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 13:57

L20	565	I13 and substrate and (IC or die or component)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 13:57
L21	565	13 and substrate and (IC or die or component)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 13:58
L22	4411	(333/32,187,193).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 13:58
L24	25910	acoustic near3 device	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/03 13:59
L25	3395	acoustic near3 wave near3 resonator	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/03 13:59
L26	1119	L24 and L25	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 13:59
L27	12840	24 and frequenc\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 14:01
L28	2324	25 and frequenc\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/03 14:01
L31	58	25 and wire near3 resonat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/03 14:03
L32	40	24 and wire near3 resonat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/03 14:03